

LV8714TA

Dual Stepper Motor Driver with Ultra-small Micro Steps

The LV8714 is a fully integrated dual bipolar/unipolar stepper motor driver with ultra-small micro step drive capability. Alternatively, it can be used to drive four DC motors independently. The device includes low $R_{DS(ON)}$ (upper + lower = 0.9Ω) type MOSFETs based quad H-bridges with gate drivers and can drive up to 1.5A per H-bridge. Synchronous rectification control is implemented for all H-bridges to lower power dissipation during a MOSFET switching. The device implements constant-current control using PWM at 125 kHz (typ.) switching frequency that enables the least noise motor drive solution. A built-in linear regulator powers internal logic circuit directly from the motor supply voltage, V_M , thus eliminating need for any external regulator.

A proprietary internal current sensing mechanism is implemented that eliminates up to four external current sense power resistors and improves the system energy efficiency significantly. External V_{REF} input signal for each H-bridge controls the drive step size and can achieve over 256 micro step resolution. Individual controls signals (ENAx and INx) are provided for controlling each H-bridge channel independently with forward and reverse direction control. To enhance energy efficiency further, the device can be put into a power saving standby mode, when idle.

Features

- Integrated quad H-bridges with independent controls
 - Dual bipolar/unipolar stepper motor or quad DC motor drive
 - Forward and reverse direction control
- Low $R_{DS(ON)}$ (upper + lower = 0.9Ω) type MOSFETs
- Proprietary internal current sensing
 - Eliminates up to four external current sense power resistors
- Over 256 micro step resolution with external V_{REF} inputs
- Single supply operation with a built-in internal regulator
- No external component for driving internal MOSFETs
- Constant-current control with 125 kHz (typ.) PWM switching frequency
- Low power standby mode when idle
- Synchronous rectification to reduce power dissipation
- In-built system protection features such as:
 - Under-voltage
 - Over-current
 - Over-temperature

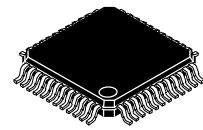
Typical Applications

- Surveillance Camera
- Stage light
- Scanner
- Printer



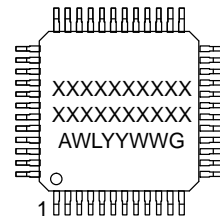
ON Semiconductor[®]

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48-pin TQFP with exposed pad
7 mm x 7 mm

MARKING DIAGRAM



XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Ordering Code:
LV8714TA-NH

Package
TQFP48 EP
(Pb-Free / Halogen Free)

Shipping (Qty / packing)
1000 / Tape & Reel

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BLOCK DIAGRAM

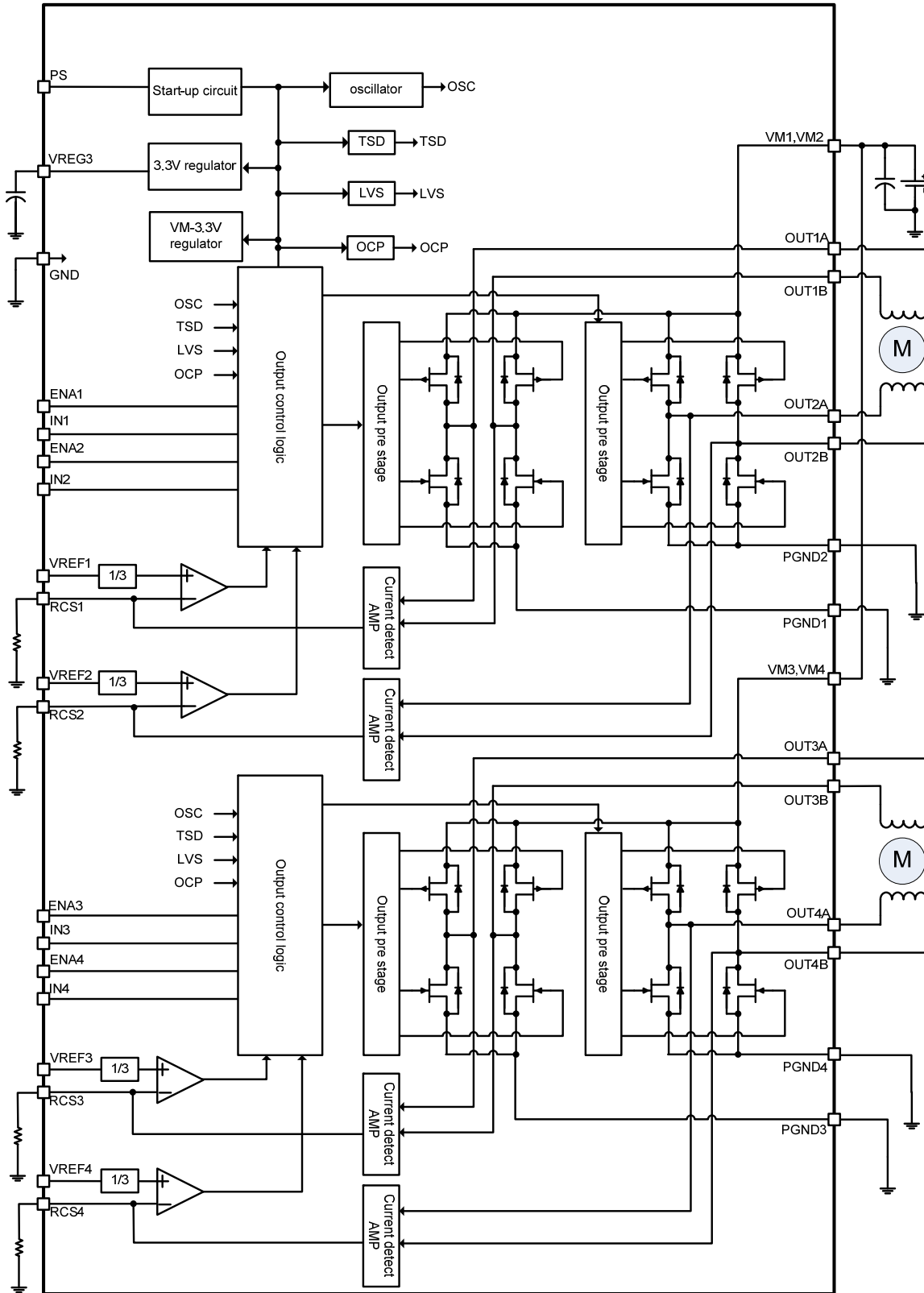


Figure 1. LV8714TA Block Diagram

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APPLICATION CIRCUIT EXAMPLES

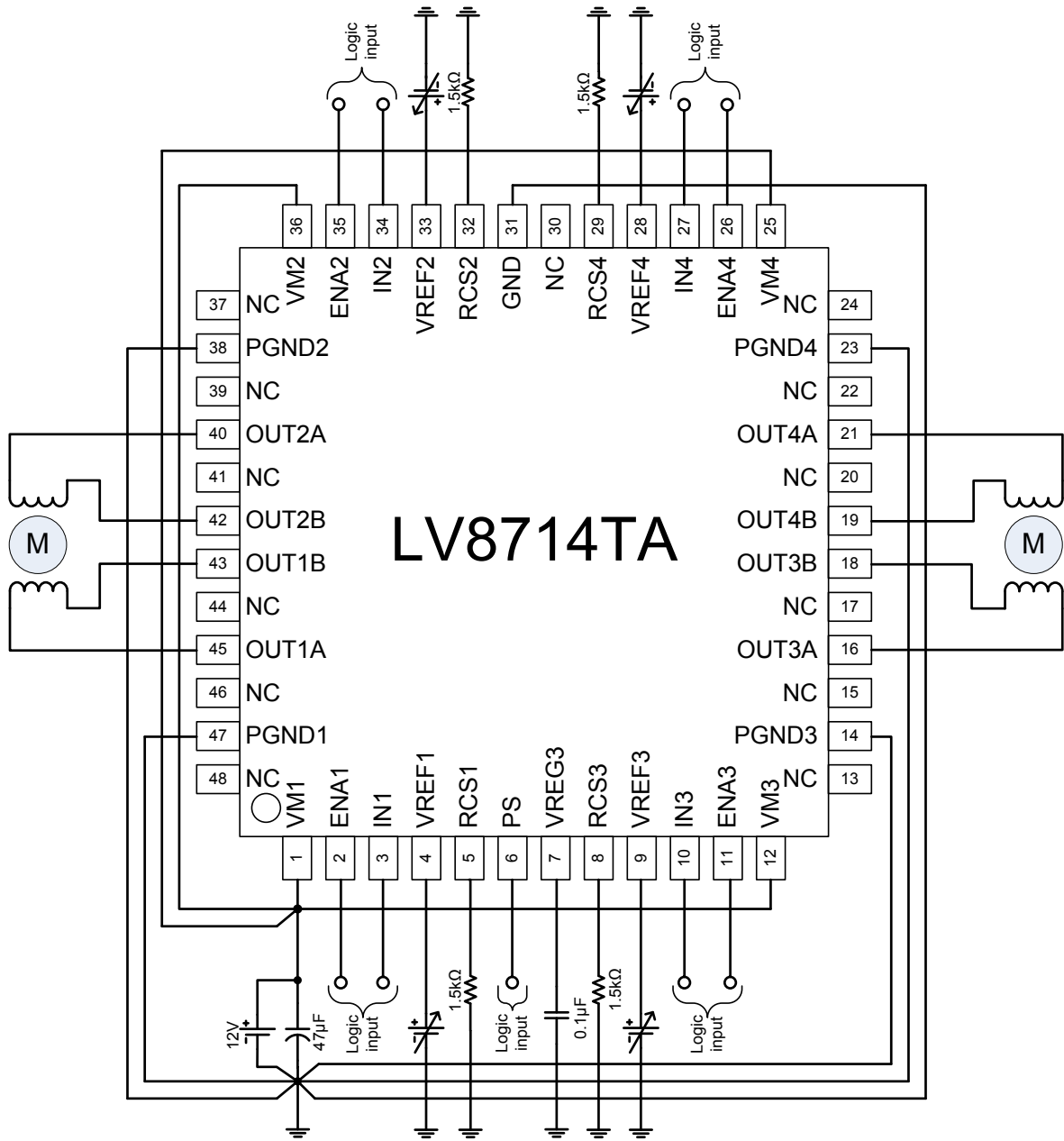


Figure 2. Two Bipolar Stepper motor Drive Using LV8714TA

LV8714TA

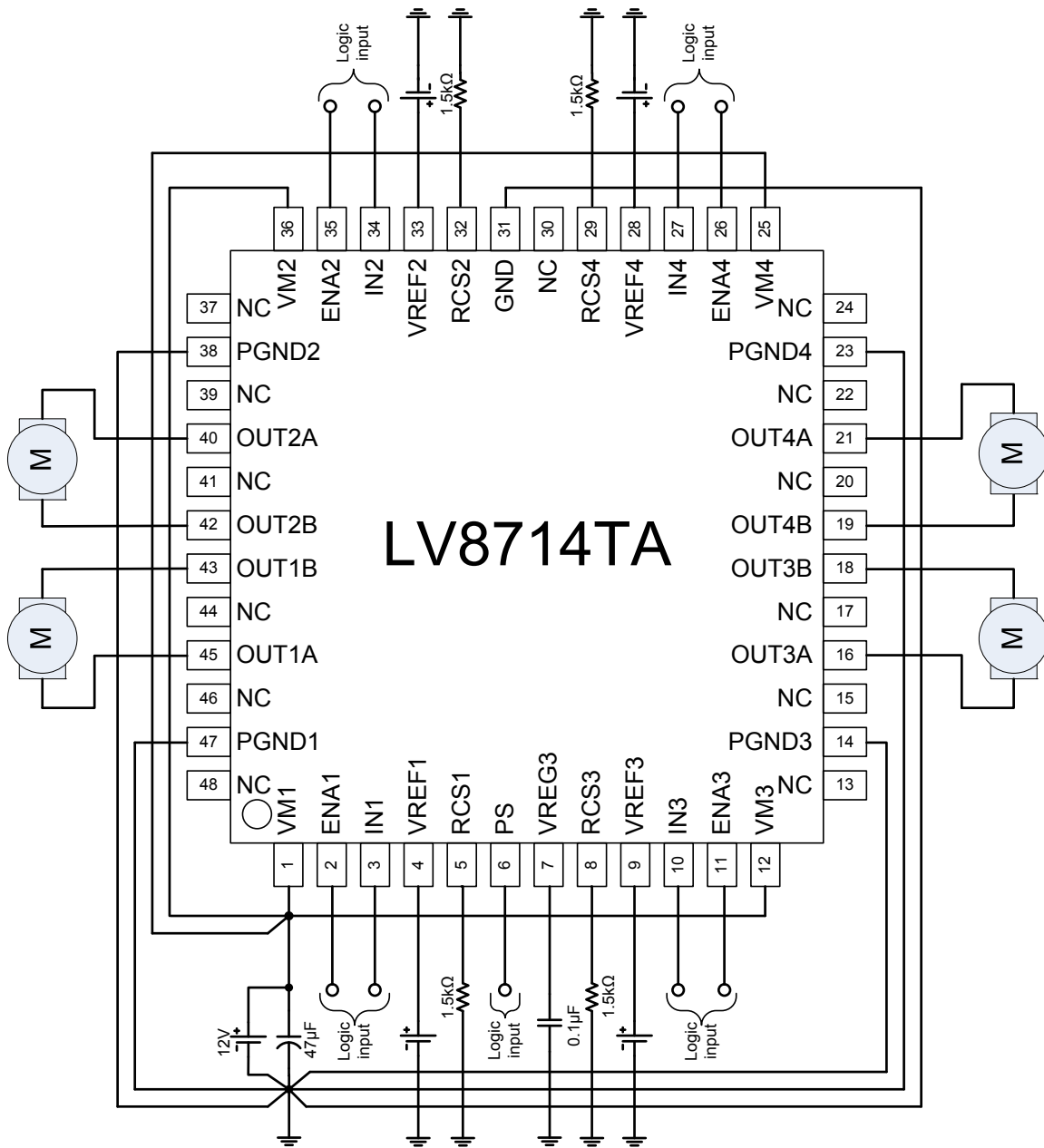


Figure 3. Four Brushed DC motor Drive Using LV8714TA

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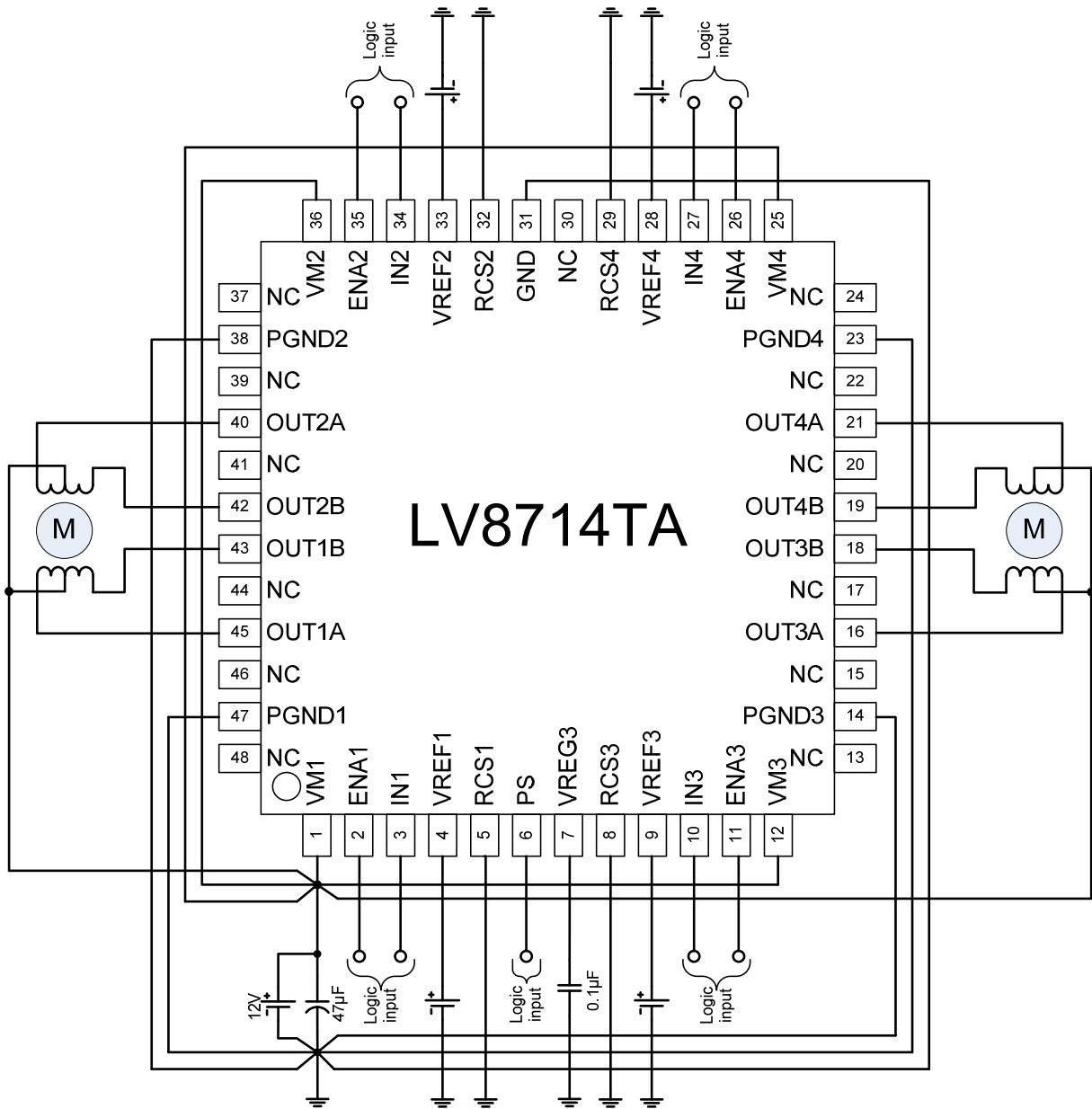


Figure 4. Two Unipolar Stepper motor Drive Using LV8714TA

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PIN ASSIGNMENT

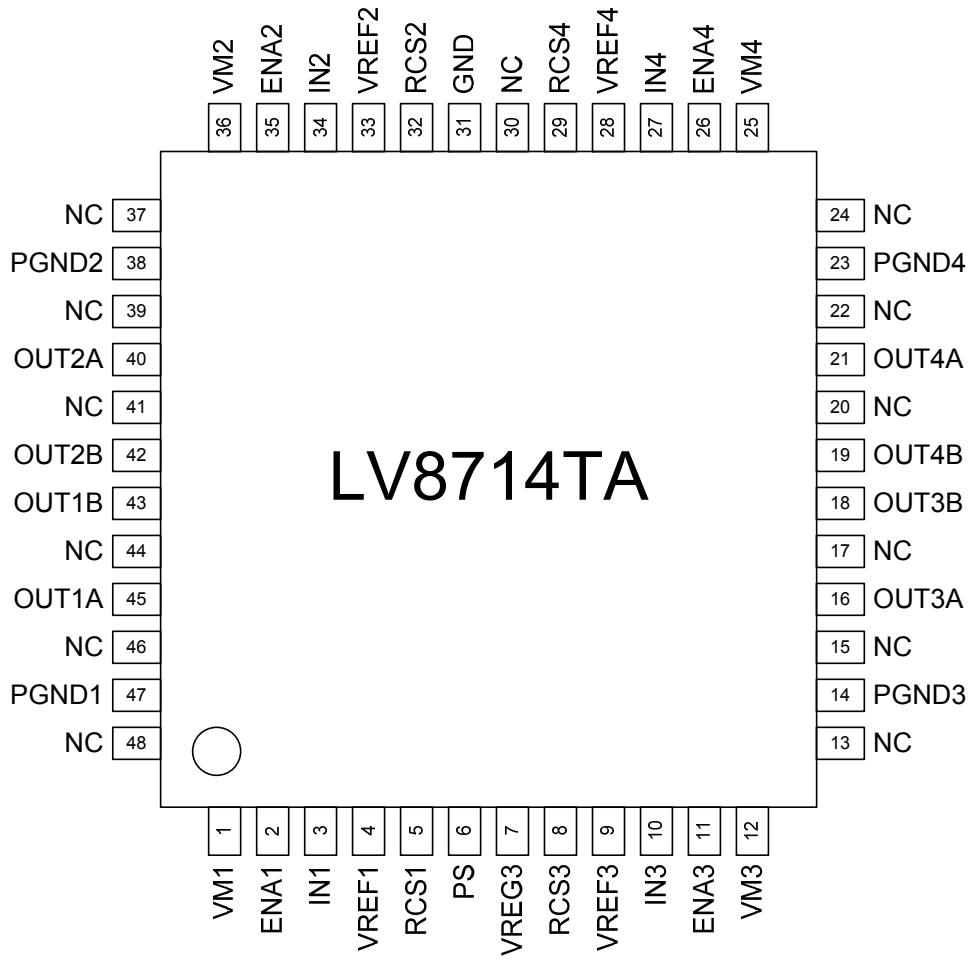


Figure 5. Pin Assignment

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PIN FUNCTION DISCRPTION

Pin No.	Pin Name	Description
1	VM1	Motor power supply pin for channel 1
2	ENA1	Enable control pin of channel 1
3	IN1	Input control pin of channel 1
4	VREF1	Reference voltage input pin of channel 1
5	RCS1	Current sense resistor pin of channel 1
6	PS	Power save mode selection pin
7	VREG3	Internal 3.3V voltage regulator pin
8	RCS3	Current sense resistor pin of channel 3
9	VREF3	Reference voltage input pin of channel 3
10	IN3	Input control pin of channel 3
11	ENA3	Enable control pin of channel 3
12	VM3	Motor power supply pin for channel 3
13	NC	No connection
14	PGND3	Channel 3 power ground pin
15	NC	No connection
16	OUT3A	Channel 3 phase output A pin
17	NC	No connection
18	OUT3B	Channel 3 phase output B pin
19	OUT4B	Channel 4 phase output B pin
20	NC	No connection
21	OUT4A	Channel 4 phase output A pin
22	NC	No connection
23	PGND4	Channel 4 power ground pin
24	NC	No connection
25	VM4	Motor power supply pin for channel 4
26	ENA4	Enable control pin of channel 4
27	IN4	Input control pin of channel 4
28	VREF4	Reference voltage input pin of channel 4
29	RCS4	Current sense resistor pin of channel 4
30	NC	No connection
31	GND	Ground pin
32	RCS2	Current sense resistor pin of channel 2
33	VREF2	Reference voltage input pin of channel 2
34	IN2	Input control pin of channel 2
35	ENA2	Enable control pin of channel 2
36	VM2	Motor power supply pin for channel 2
37	NC	No connection
38	PGND2	Channel 2 power ground pin
39	NC	No connection
40	OUT2A	Channel 2 phase output A pin
41	NC	No connection
42	OUT2B	Channel 2 phase output B pin
43	OUT1B	Channel 1 phase output B pin
44	NC	No connection
45	OUT1A	Channel 1 phase output A pin
46	NC	No connection
47	PGND1	Channel 1 power ground pin
48	NC	No connection

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MAXIMUM RATINGS (Note 1)

Parameter	Symbol	Value	Unit
Motor Supply Voltage (Note 2)	V_M	18	V
Logic Input Voltage (Note 3)	V_{IN}	6	V
Output Peak Current per channel (Note 4)	$I_{O(peak)}$	1.75	A
Output current per channel	$I_{O(max)}$	1.5	A
Allowable Power Dissipation (Note 5)	P_d	4.86	W
Storage Temperature	T_{stg}	-55 to 150	°C
Junction Temperature	T_J	150	°C
Moisture Sensitivity Level (MSL) (Note 6)	MSL	3	-
Lead Temperature Soldering Pb-Free Versions (10sec or less) (Note 7)	T_{SLD}	260	°C

1. Stresses exceeding those listed in the Absolute Maximum Rating table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
2. Motor power supply pins are VM1, VM2, VM3 and VM4.
3. Logic input pins are PS, ENA1, IN1, ENA2, IN2, ENA3, IN3, ENA4 and IN4.
4. Condition for measuring the output peak current is that total time duration ≤ 10 ms (PWM duty cycle = 20%) at each channel.
5. Specified circuit board : 90mm \times 90mm \times 1.6mm, glass epoxy 4-layer board, with backside mounting. It has 1 oz internal power and ground planes and 1/2 oz copper traces on top and bottom of the board. Please refer to Thermal Test Conditions of page 23.
6. Moisture Sensitivity Level (MSL): 3 per IPC/JEDEC standard: J-STD-020A
7. For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D
<http://www.onsemi.com/pub/link/Collateral/SOLDERRM-D.PDF>

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient (Note 5)	$R_{\theta JA}$	25.7	°C/W
Thermal Resistance, Junction-to-Case (Top) (Note 5)	$R_{\psi JT}$	6	°C/W

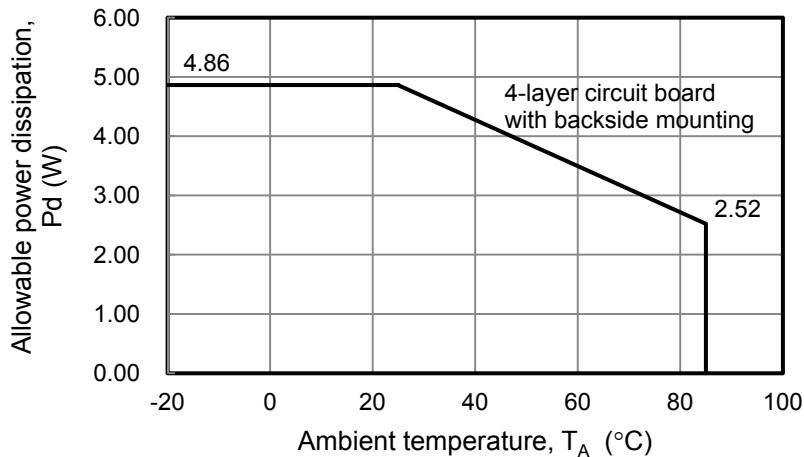


Figure 6. Power Dissipation vs Ambient Temperature Characteristic

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RECOMMENDED OPERATING RANGES (Note8)

Parameter	Symbol	Ratings	Unit
Motor Supply Voltage Range (Note 2)	V_M	4 to 16.5	V
Logic Input Voltage Range (Note 3)	V_{IN}	-0.3 to 5.5	V
VREF Input Voltage Range	V_{REF}	0 to 1.5	V
Ambient Temperature	T_A	-20 to 85	°C

8. Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

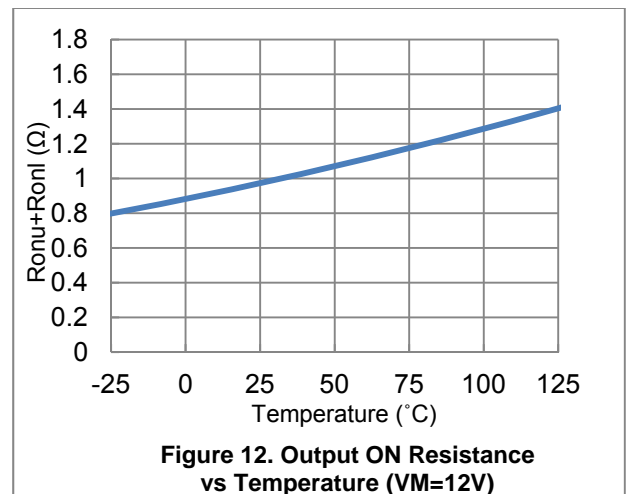
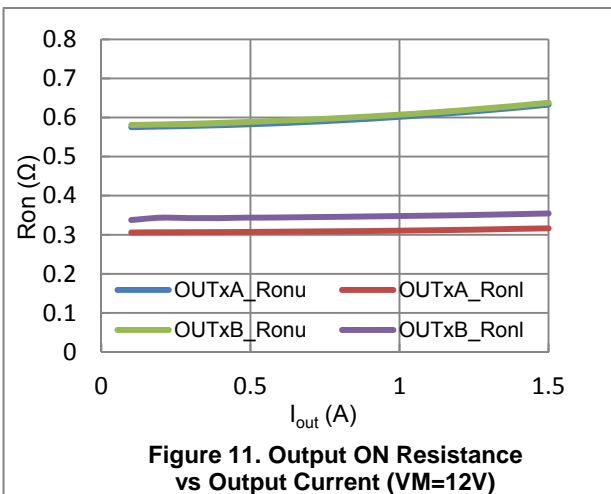
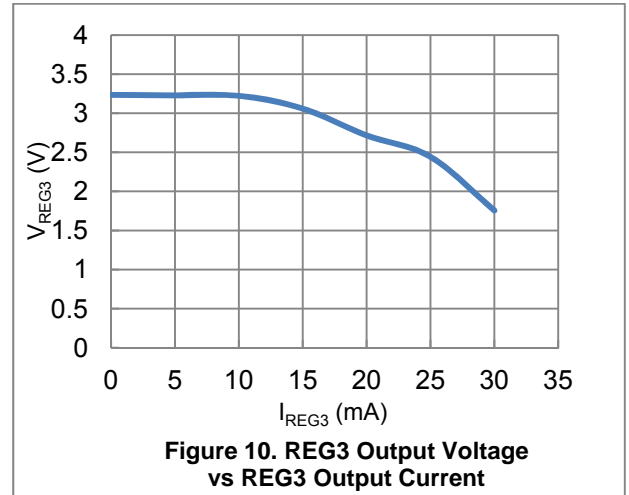
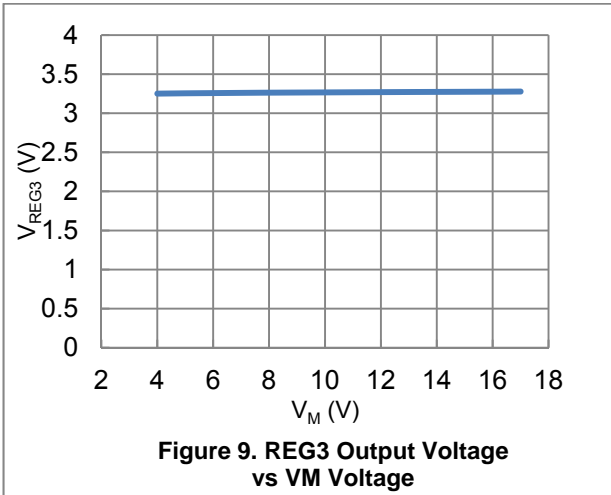
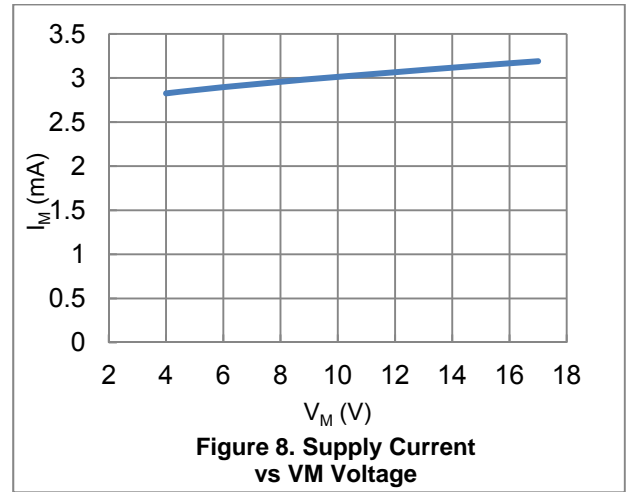
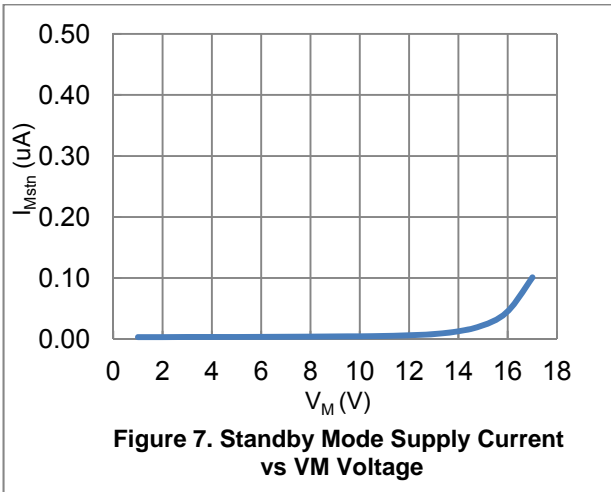
ELECTRICAL CHARACTERICALS

$T_A=25^\circ\text{C}$, $V_M = 12\text{V}$, $V_{REF}=0.6\text{V}$ unless otherwise noted. (Note 9)

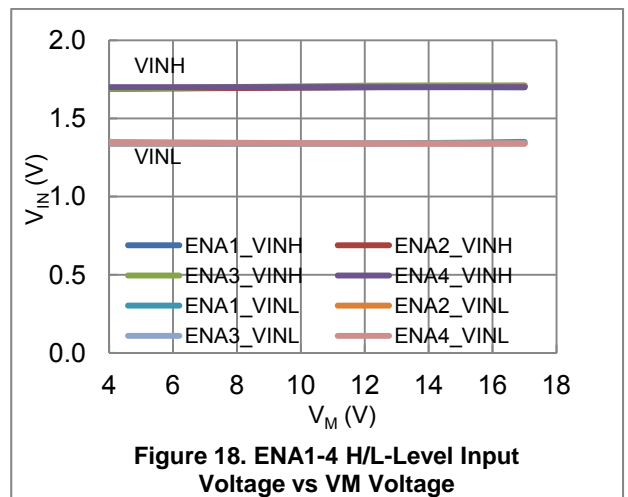
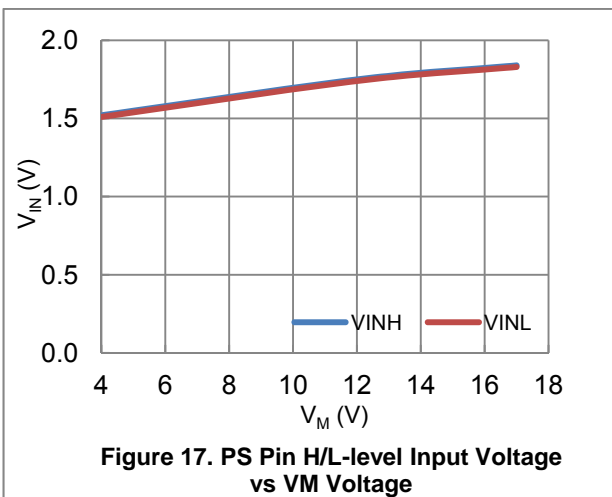
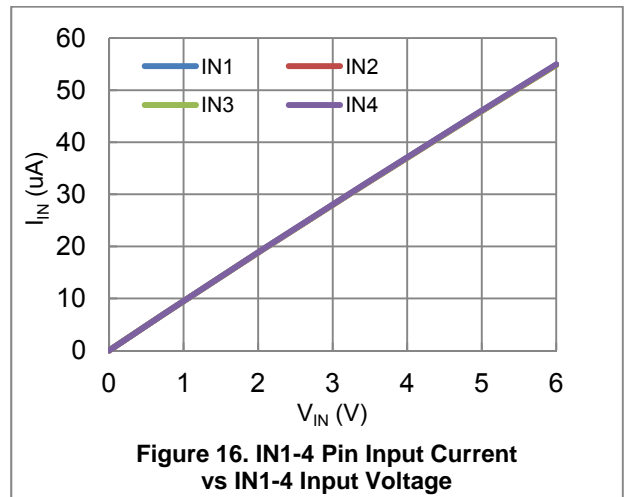
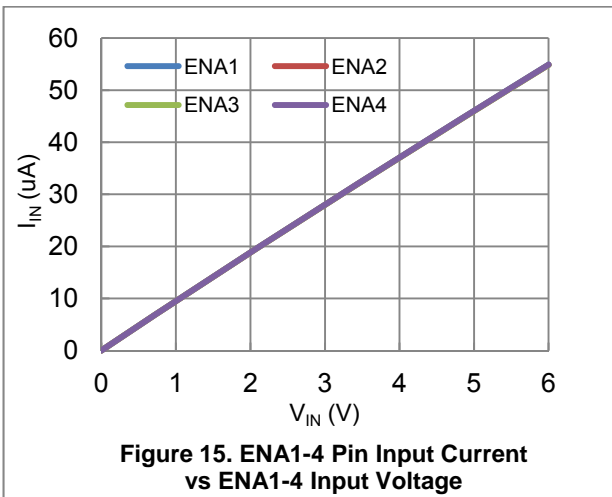
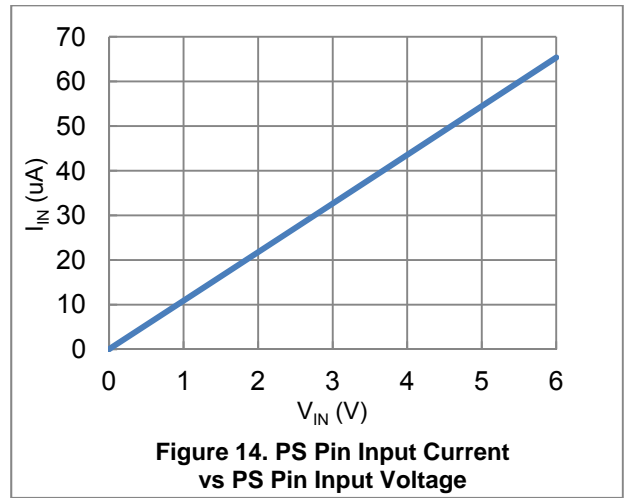
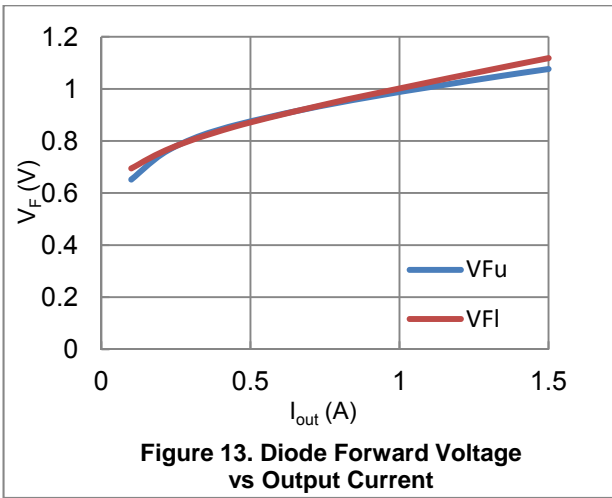
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Standby Mode Current	I_{Mstn}	$I_{M1}(VM1)+I_{M2}(VM2)+I_{M3}(VM3)+I_{M4}(VM4)$, PS="L", No load		0	1	μA
Supply Current	I_M	$I_{M1}(VM1)+I_{M2}(VM2)+I_{M3}(VM3)+I_{M4}(VM4)$, PS="H", No load		3.2	4.2	mA
Thermal Shutdown Temperature	TSD	Guaranteed by design	150	180		°C
Thermal hysteresis width	ΔTSD	Guaranteed by design		40		°C
Regulator						
REG3 Output Voltage	V_{REG3}		3	3.3	3.6	V
Output						
Output On Resistance	R_{onU}	$I_O=-1.5\text{A}$, Upper side		0.6	0.85	Ω
	R_{onL}	$I_O=1.5\text{A}$, Lower side		0.3	0.5	Ω
Output leakage current	I_{Oleak}	$V_M=16.5\text{V}$			10	μA
Diode forward voltage	V_F	$I_F=-1.5\text{A}$		1.2	1.6	V
Logic Input						
Logic Pin Input Current	I_{INL}	PS,ENA1,IN1,ENA2,IN2,ENA3,IN3,ENA4,IN4, $V_{IN}=0.8\text{V}$	4.8	8	13.3	μA
	I_{INH}	PS,ENA1,IN1,ENA2,IN2,ENA3,IN3,ENA4,IN4, $V_{IN}=3.3\text{V}$	20	33	55	μA
Logic Input Voltage	High	V_{INH}	2.0		5.5	V
	Low	V_{INL}	0		0.8	V
PWM Current Control						
VREF Pin Input Current	I_{REF}	$V_{REF1},V_{REF2},V_{REF3},V_{REF4}$ $V_{REF}=1.5\text{V}$	-0.5			μA
Current Detection Reference Voltage	V_{REFdet}	$V_{REF1},V_{REF2},V_{REF3},V_{REF4}$ $V_{REF}=0.6\text{V}$	0.18	0.2	0.22	V
PWM (Chopping) Frequency	Fchop		100	125	150	kHz
Output current detection current	Ircs	RCS1,RCS2,RCS3,RCS4, $I_o=0.5\text{A}$,RSC=0V	115	125	137	μA

9. Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

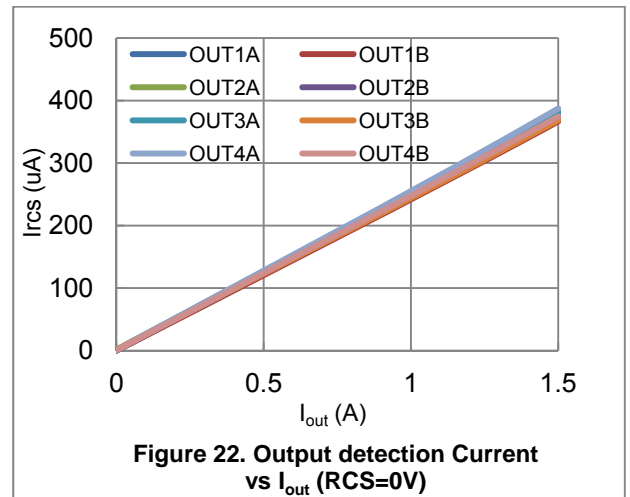
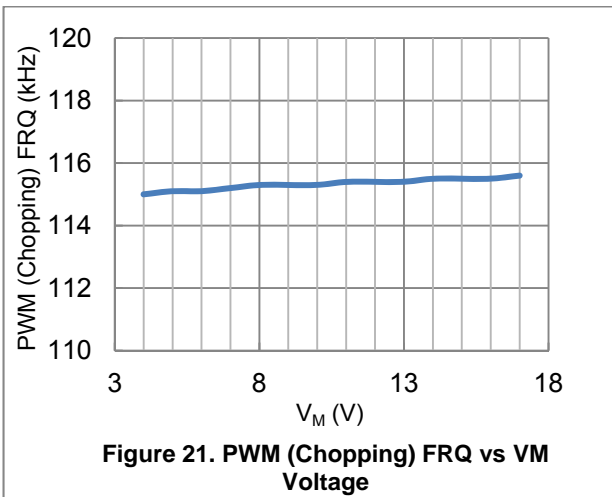
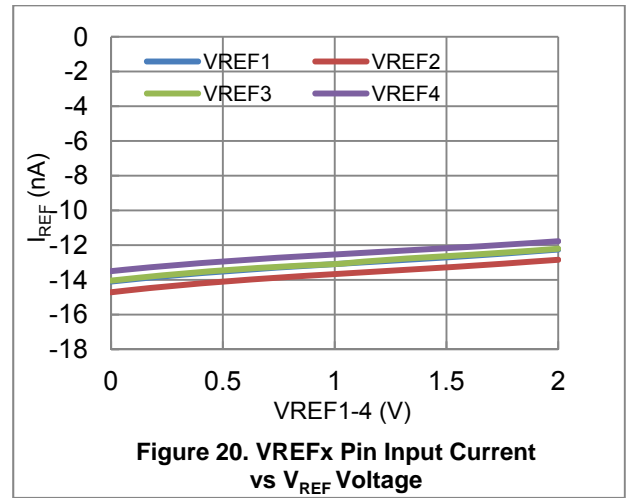
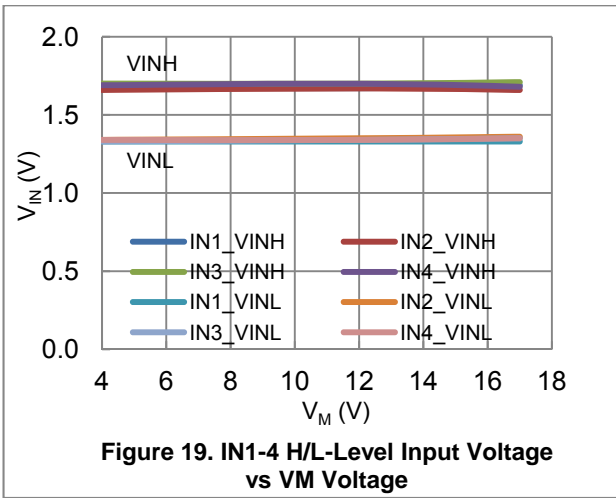
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



FUNCTIONAL DESCRIPTION

Power Supply Pins (VM1, VM2, VM3 AND VM4)

The LV8714 has four power supply pins, VM1, VM2, VM3, and VM4, connected internally. Hence, it is must that all power supply pins are connected to the same power supply rail externally. VM1 also supplies power to internal circuits through an internal voltage regulator.

It is highly recommended to provide a decoupling capacitor of 47µF close to the VM1 pin.

Internal 3.3V Voltage Regulator Pin (VREG3)

An internal 3.3V voltage regulator acts a power source for internal logic, oscillator, and protection circuits. Output of this regulator is connected to the VREG3 pin. Do not use the VREG3 pin to drive any external load. It is recommended to connect a 0.1µF decoupling capacitor to the VREG3 pin.

Internal Regulator (VM-3.3V)

An VM-3.3V regulator is integrated in the LV8714. This regulator provides required biasing for upper MOSFETs of each channel.

Power Save Mode Selection Pin (PS)

When the LV8714 is idle, to save power, it can be put to a power saving, Standby mode by applying logic low to the PS pin. While in the Standby mode, all internal circuits of the LV8714 including voltage regulators are put into inactive state. Table 1 shows mode selection of the LV8714 using the PS pin

Logic Input at PS Pin	Mode	Internal Circuits
Low or Open	Standby	Inactive
High	Operating	Active

Table 1: LV8714 mode selection using the PS pin

Figure 23 shows an equivalent internal circuit of the PS pin input.

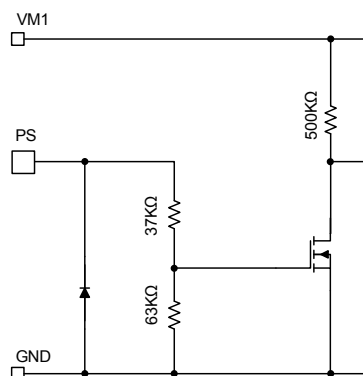


Figure 23. Equivalent circuit of the PS pin

Channel Control Pins (ENAx, INx)

Each channel of the LV8714 is controlled independently by corresponding ENAx and INx pins. Figure 24 shows an equivalent internal circuit of these input pins.

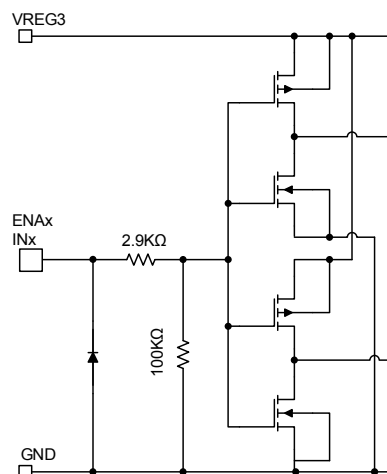


Figure 24. Equivalent circuit of ENAx, INx

Motor Drive Output Pins (OUTxx)

The LV8714 has quad built-in H-bridges for driving stepper or DC motors. Each H-bridge (channel) is made up of upper side P-MOSFETs and lower side N-MOSFETs. Output of each channel is connected to OUTxA or OUTxB pins. When a channel is configured to drive a stepper motor in forward direction, OUTxA becomes high output and in reverse direction, OUTxB becomes high output.

Reference Voltage Input Pins (VREFx)

Step size of a stepper motor drive is controlled by providing a reference voltage signal at VREFx pin for each channel. Resolution of the VREFx input enables ultra-small micro step drive of a stepper motor in combination with the INx input. The coil current is proportional to the analog voltage amplitude at the VREFx pin.

Figure 25 shows an equivalent circuit of VREFx input pins.

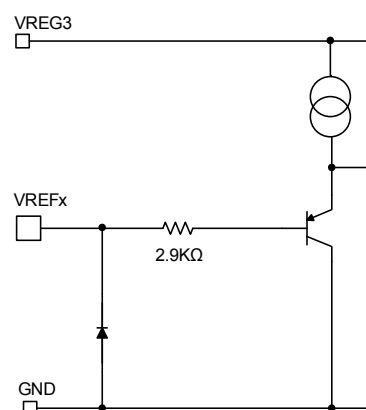


Figure 25. Equivalent circuit of VREF1-4

Current Sense Resistor Pins (RCSx)

The LV8714 implements a proprietary current sense mechanism for each channel and doesn't require any external current sense power resistor, thus providing

loss-less current control that improves the energy efficiency of the system.

To control a coil current, the individual RCSx pin is provided for each channel. A resistor connected at this RCSx pin decides the coil current. The coil current is sensed internally and fed back to RCS pin with the ratio of 1/4000. And, the output duty cycle adjusted such that the RCSx voltage level is equal to 1/3 of the VREFx pin voltage. Figure 26 shows the equivalent circuit of current control.

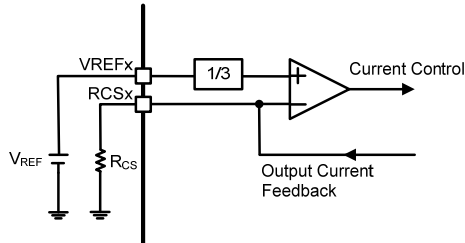


Figure 26. Equivalent circuit of current control

Equation 1 is utilized to calculate the coil current, I_{OUT} .

$$\frac{I_{OUT}}{4000} \cdot R_{CS} = \frac{V_{REF}}{3} \dots \dots \dots (1)$$

Where,

I_{OUT} = Coil current [A]

R_{CS} = Resistance between RCSx and GND [Ω]

V_{REF} = Input voltage at the VREFx pin [V]

For example, in case of

$$R_{CS} = 1k\Omega$$

$$V_{REF} = 0.6V$$

The coil current is

$$I_{OUT} = \frac{4000 \times 0.6}{3 \times 1000} = 0.8A$$

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DETAILED DESCRIPTION

Stepper Motor Direction Control

The stepper motor rotation direction is determined by phase lead/lag relation between INx inputs of the LV8714 as shown in Table 2 and Table 3.

INx	ENA1, ENA2	Phase				Direction
		0-90	90-180	180-270	270-360	
IN1	H	L	L	H	H	Forward
IN2	H	H	L	L	H	
IN1	H	H	L	L	H	Reverse
IN2	H	L	L	H	H	

Table 2: Stepper Motor Direction control by IN1 and IN2

INx	ENA3, ENA4	Phase				Direction
		0-90	90-180	180-270	270-360	
IN3	H	L	L	H	H	Forward
IN4	H	H	L	L	H	
IN3	H	H	L	L	H	Reverse
IN4	H	L	L	H	H	

Table 3: Stepper Motor Direction control by IN3 and IN4

DC Motor Direction Control

The LV8714 utilizes ENAx and INx to control the DC motor rotation direction as shown in Table 4.

Input signal		Output		Direction
ENAx	INx	OUTxA	OUTxB	
L	-	Off	Off	
H	L	High	Low	Forward
H	H	Low	High	Reverse

X represents a channel number

Table 4: DC Motor Direction Control by ENAx and INx

Stepper Motor Coil Current Control

Stepper motor coil current is controlled in proportional to VREFx and RCSx as shown in equation 1 previously. Two phase outputs (A and B) for each stepper motor are controlled by combination of INx and VREFx inputs as shown in Table 5.

Input			Output (coil current)	
INx	VREFx	ENAx	Amplitude	Polarity
Low	Analog	High	Proportional to VREFx	A to B
High	Analog	High	Proportional to VREFx	B to A

Table 5: Stepper Motor Coil Current Control

Figure 27 and 28 show example waveforms of output current with in response to VREFx, ENAx and INx input.

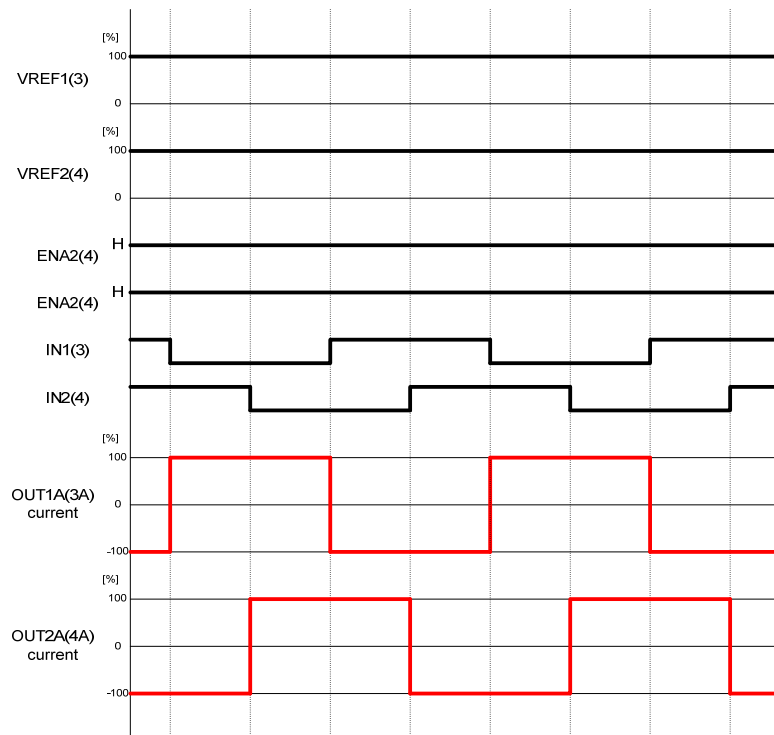


Figure 27. Example waveforms for full step (forward) control

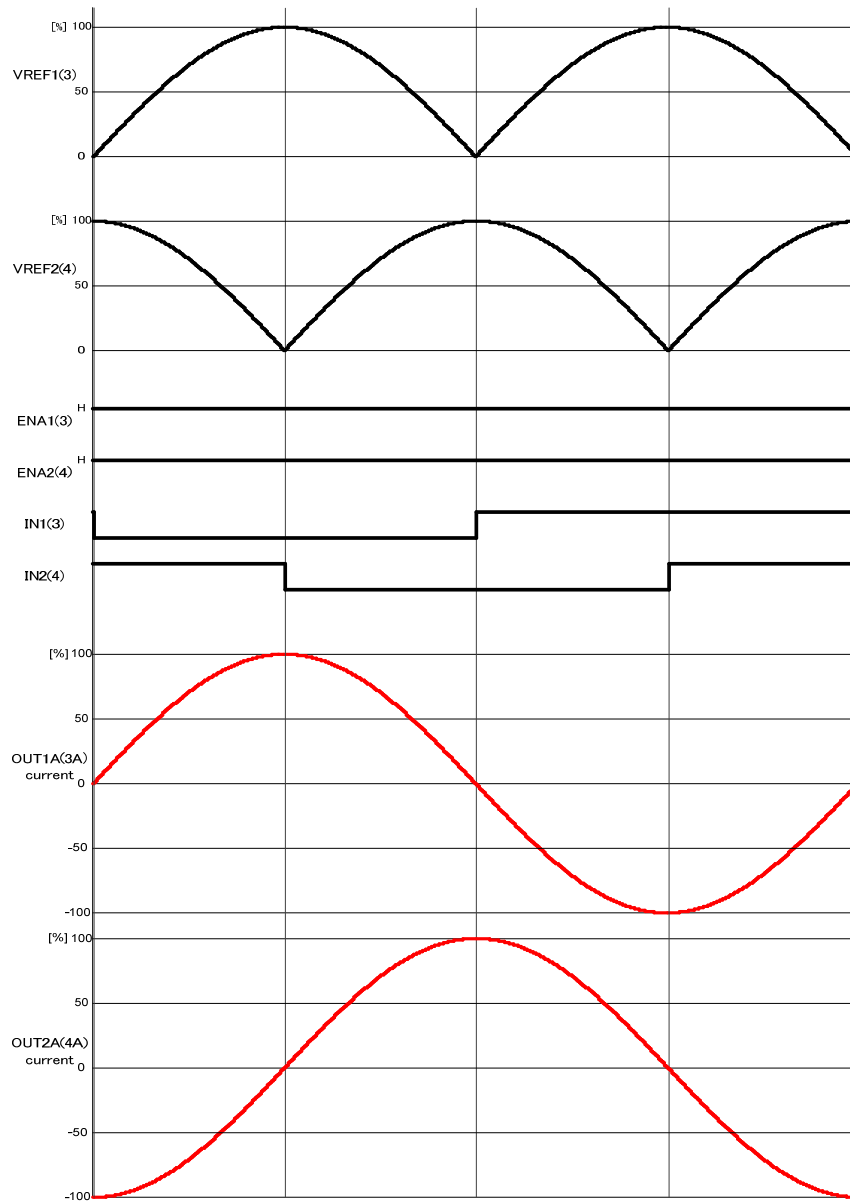


Figure 28. Example waveforms for 1/256 step (forward) control

PWM Constant-Current Control

The LV8714 implements constant-current control drive by applying PWM switching to the output pin.

When the coil current becomes equal to the set target value (as determined by equation 1), the constant current control mechanism gets activated and performs a repetitive sequence of Charge → Slow Decay → Fast Decay (fixed 2μs) → Charge... as shown in Figure 29. The period for each sequence is fixed at 8μs(typ.).

Figure 29 shows timing chart of PWM based constant-current control.

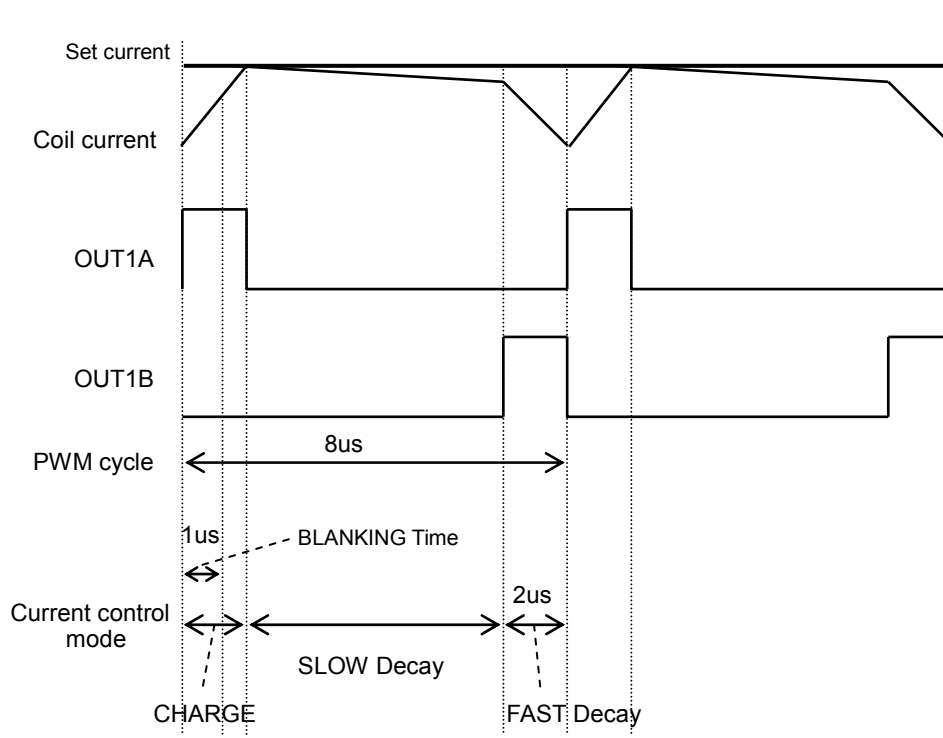


Figure 29. Timing chart of PWM based constant-current

Three Modes of Constant-Current Control

Each PWM cycle of constant-current control is made up of three distinct intervals – Charge, Slow Decay and Fast Decay.

Example: Current direction A to B

Charge:

Voltage is applied to the coil until the coil current becomes equal to the target (A = High, B = Low).

Slow Decay:

Output A and B are shorted internally resulting in circular current (A = Low, B = Low).

Fast Decay:

Inverted bias is applied to discharge the coil current (A = Low, B = High) that results in decreases of the coil current.

These intervals (Charge, Slow Decay and Fast Decay) are results of MOSFET switching as shown in Figure 30.

LV8714TA

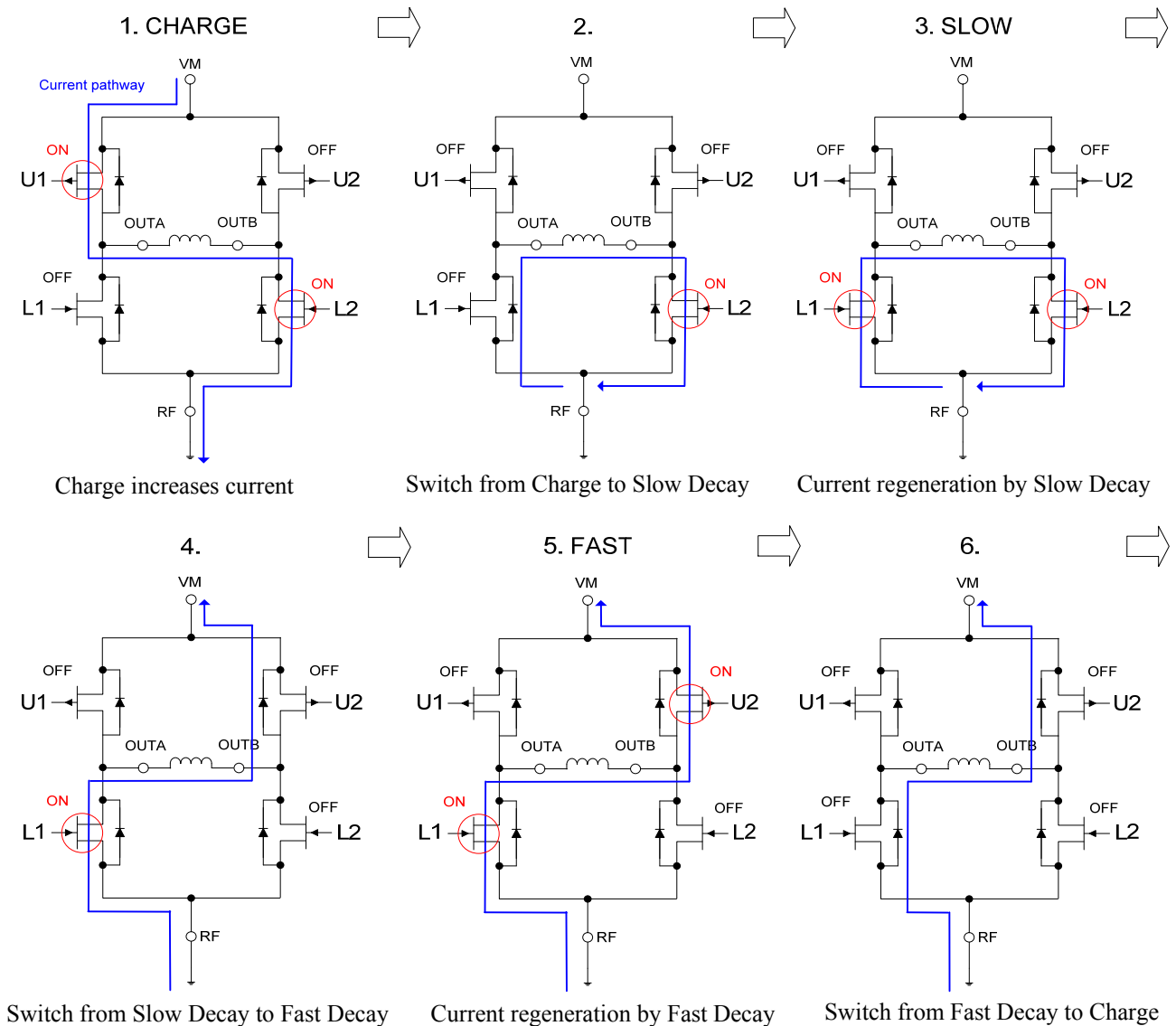


Figure 30. MOSFET switching sequence for constant-current control

Whenever, there is a switch from the upper MOSFET to the lower MOSFET of the same leg, the fixed dead time of $0.375\mu\text{s}$ is provided to avoid turning on both MOSFETs on at the same time. During this time, the coil current flows through the body diode of the MOSFET as seen in (2), (4) and (6) events in figure 30.

Table 6 and Table 7 show status of MOSFETs during various intervals in a PWM cycle for different current polarities.

OUTxA→OUTxB

Output Tr	CHARGE	SLOW Decay	FAST Decay
U1	ON	OFF	OFF
U2	OFF	OFF	ON
L1	OFF	ON	ON
L2	ON	ON	OFF

Table 6: MOSFET Switching Sequence for OUTxA→OUTxB polarity

OUTxB→OUTxA

Output Tr	CHARGE	SLOW Decay	FAST Decay
U1	OFF	OFF	ON
U2	ON	OFF	OFF
L1	ON	ON	OFF
L2	OFF	ON	ON

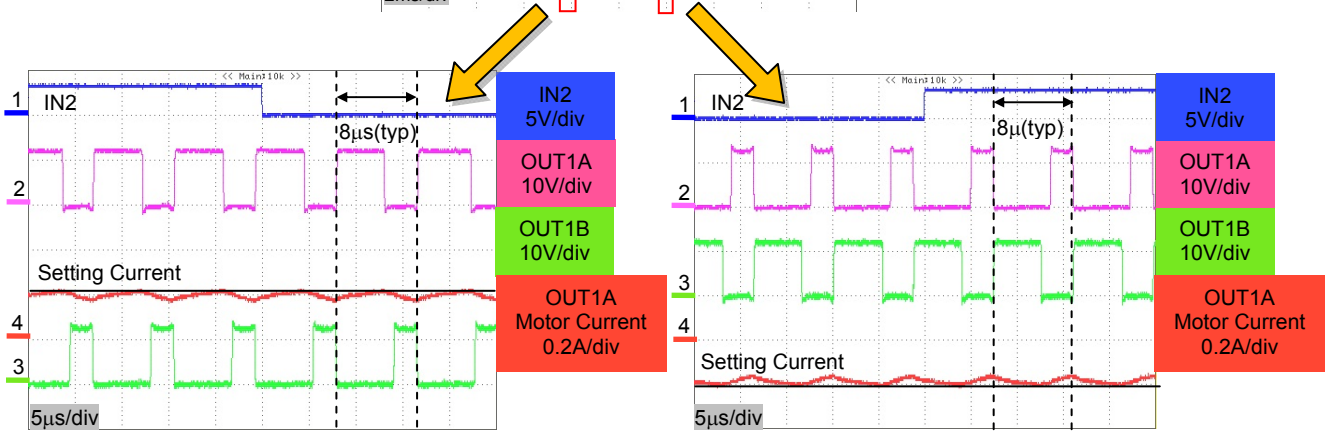
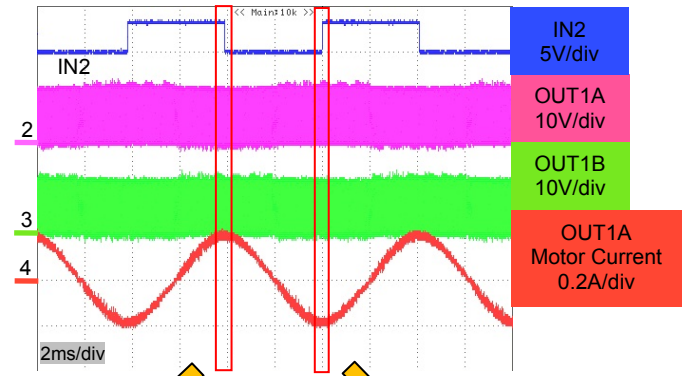
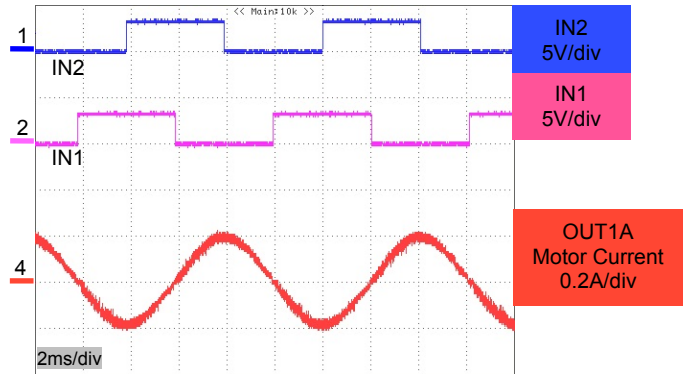
Table 7: MOSFET Switching Sequence for OUTxB→OUTxA polarity

Figure 31 shows example waveforms of the stepper motor with 1/16 step and constant-current control.

Figure 32 shows example waveforms of three events – Charge, Slow Decay and Fast Decay.

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1/16 step
 VM=12V
 VREF1/2=0.23V
 (Iout≈0.2A)
 RCS1/2=1.5kΩ
 IN1=IN2≈ 125Hz
 Rcoil=15Ω



Constant current control is synchronized to the internal PWM period 8µs (typ).

Figure 31. PWM based constant-current control waveforms of the stepper motor with 1/16 step

VM=12V
 VREF1/2=0.11V
 (Iout≈0.1A)
 RCS1/2=1.5kΩ
 IN1=IN2=100Hz
 Rcoil=15Ω

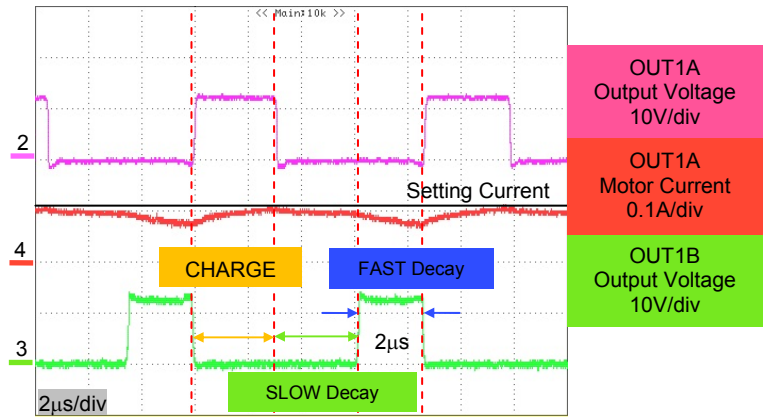


Figure 32. One full PWM cycle of the constant-current control

Blanking Time

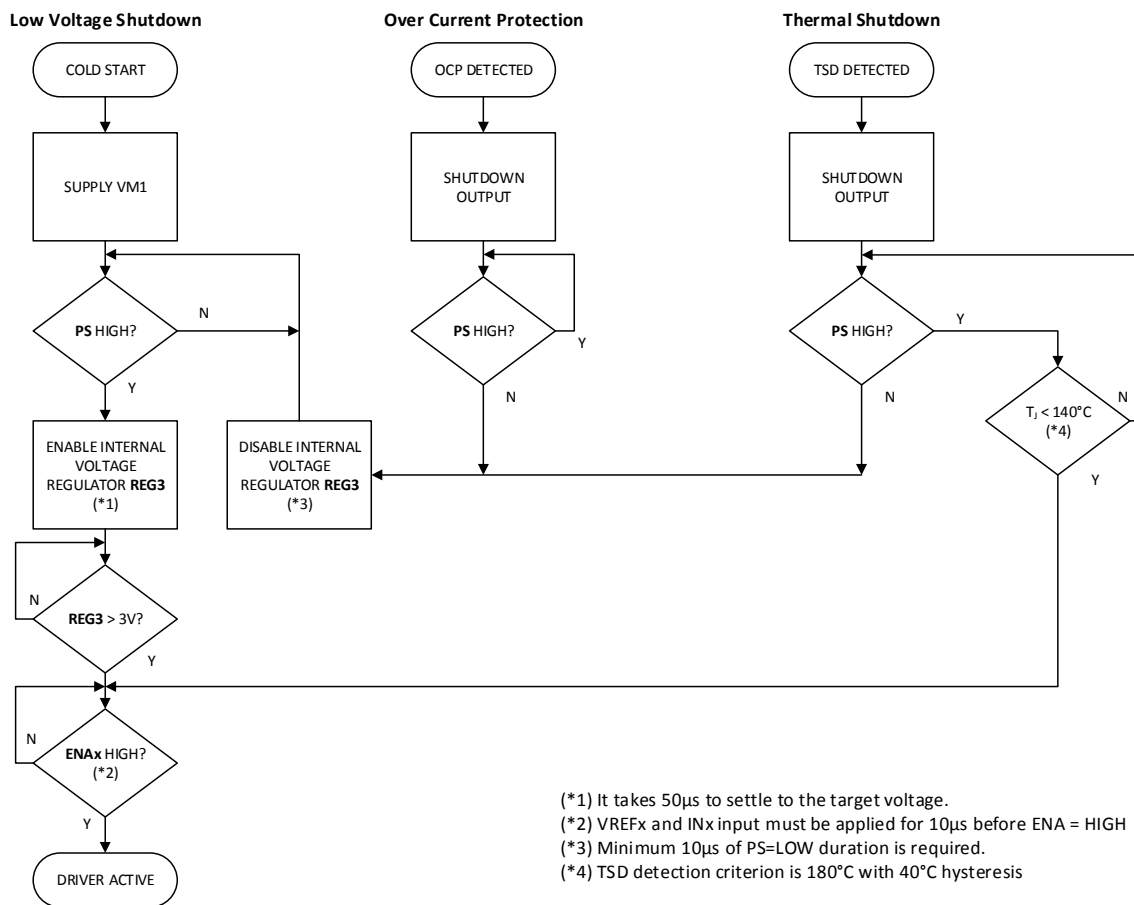
As the LV8714 switches from Fast Decay to Charge, switching noise can lead to wrong reading by the comparator that is comparing the coil current against the target current. To filter out this switching noise, a fixed 1μs blanking time is provided at the beginning of the Charge interval.

During this blanking time, the comparator ignores the coil current reading and thus avoid false switching to the Slow Decay interval, if the comparator detects the coil current higher than the target current.

Power-on Reset (POR) Sequence

At startup, when $VM1 \geq 4V$ and $PS = High$, it takes 50μs for the internal 3.3V regulator to provide stable output. After the 3.3V regulator is in the active state, $ENAx$ needs to be pulled high to enable respective channel output. It is recommended that $VREFx$ input is never floating and the required input signal is applied at least 10μs before $ENAx$ is pulled high. Figure 33 shows POR and fault handling sequence.

POR and Fault Handling Operation Flow



(*1) It takes 50μs to settle to the target voltage.
 (*2) $VREFx$ and INx input must be applied for 10μs before $ENAx = HIGH$
 (*3) Minimum 10μs of $PS=LOW$ duration is required.
 (*4) TSD detection criterion is 180°C with 40°C hysteresis

Figure 33. POR and fault handling sequence

System Protection Functions

The LV8714 has built-in protection functions such as over-current (OCP), over-temperature (Thermal shutdown, TSD), and under-voltage (Low-voltage shutdown, LVS) protections. These integrated

protections make the LV8714 based system solution highly reliable without need for any external protection circuit. Table 8 shows summary of LV8714 protection functions with recovery mechanisms.

Priority	Fault Event	Condition	OUTxx	Logic	Regulator	Recovery
1	Low Voltage Shutdown LVS	$VREG3 < 2.6V$	OFF	Reset	$< 2.6V$	$VM1 \geq 4.0V$
2	Thermal Shutdown TSD	Junction temperature $> 180^{\circ}C$	OFF	Active	ON	Auto-recover when $T_j \leq 140^{\circ}C$
3	Over-current Protection OCP	Upper side FET current $> 2.6A$ Lower side FET current $> 2.0A$	OFF	Active	ON	Toggle PS input High \rightarrow Low ($\geq 10\mu s$) \rightarrow High

Table 8: Summary of LV8714 protection functions with recovery mechanisms

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Low Voltage Shutdown (LVS)

The integrated LVS protection enables safe shutdown of the system when the VM1 drops. The VREG3 voltage is monitored and the LVS is activated when the VREG3 voltage drops below 2.6V (typ.). It turns off output FETs and logic circuits are put into the reset state. The LV8714 recovers from the LVS automatically when $VM1 \geq 4V$.

Thermal Shutdown (TSD)

The built-in TSD protection prevents damage to the LV8714 from excessive heat. To avoid false trigger, the TSD protection is activated when the die T_J exceeds 180°C. Once activated, it shuts down output FETs while keeping the rest of circuit in the active state. When T_J

falls below 140°C, the output stage is reactivated under control of input signals INx, and ENAx.

Over-current Protection (OCP)

The on-chip OCP protection of the LV8714 triggers when current above the threshold is detected internally. Once detected for 2 μ s, output FETs are turned off and the internal timer is triggered to count 128 μ s (typ.) of the timer latch period. At the end of the timer latch period, output FETs are turned on again 2 μ s. If during this time, over-current is detected again, then the fault is latched and FETs are turned off. FETs can now be turned on again only when over-current condition is removed and the PS pin is toggled (High \rightarrow Low ($\geq 10\mu$ s) \rightarrow High). Timing chart of the OCP is as shown in Figure 34.

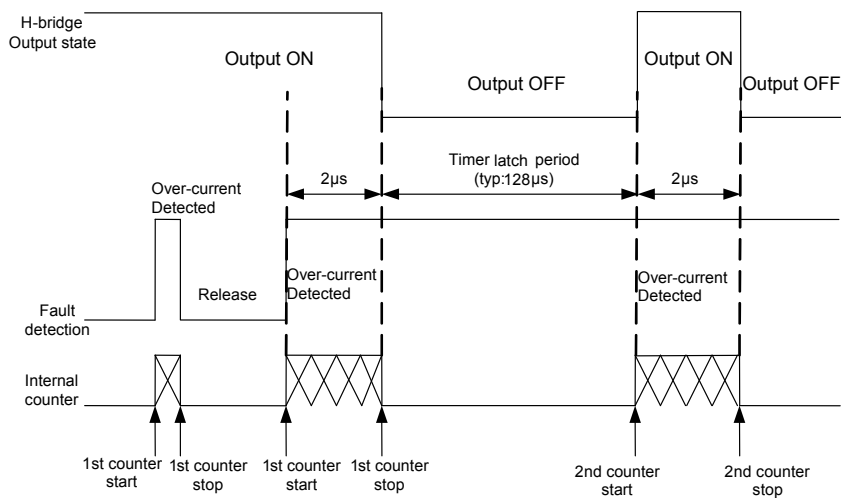
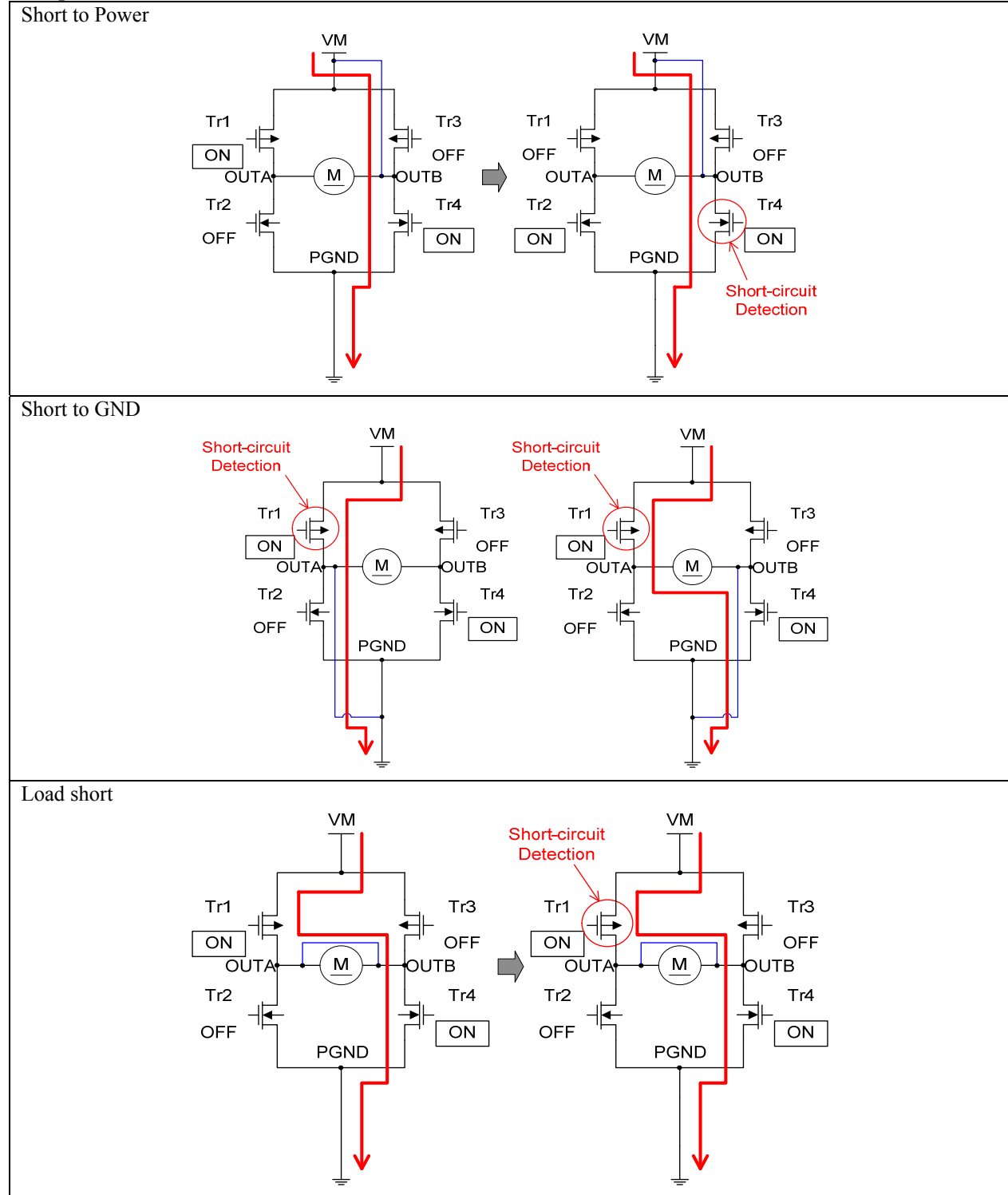


Figure 34. Timing Chart of OCP

Example of Over-current Detection:



PCB GUIDELINES

VM and Ground Routing

Make sure to short-circuit VM1, VM2, VM3 and VM4 externally by a low impedance route on one side of PCB. As high current flows into PGND, connect it to GND through a low impedance route.

Exposed Pad

The exposed pad is connected to the frame of the LV8714. Therefore, do not connect it to anywhere else other than ground. If GND and PGND are in the same plane, connect the exposed pad to the ground plane. Else, if GND and PGND are separated, connect the exposed pad to GND.

NC Pin Utilization

NC pins are not connected internally inside the LV8714. If the power track that is connected to VM, outputs and GND is wide, the power track can be connected to NC pins.

Thermal Test Conditions

Size: 90mm × 90mm × 1.6mm (four layer PCB)

Material: Glass epoxy

Copper wiring density: L1 = 80% / L4 = 85%

Second layer is VM power supply layer.

Third layer is GND layer

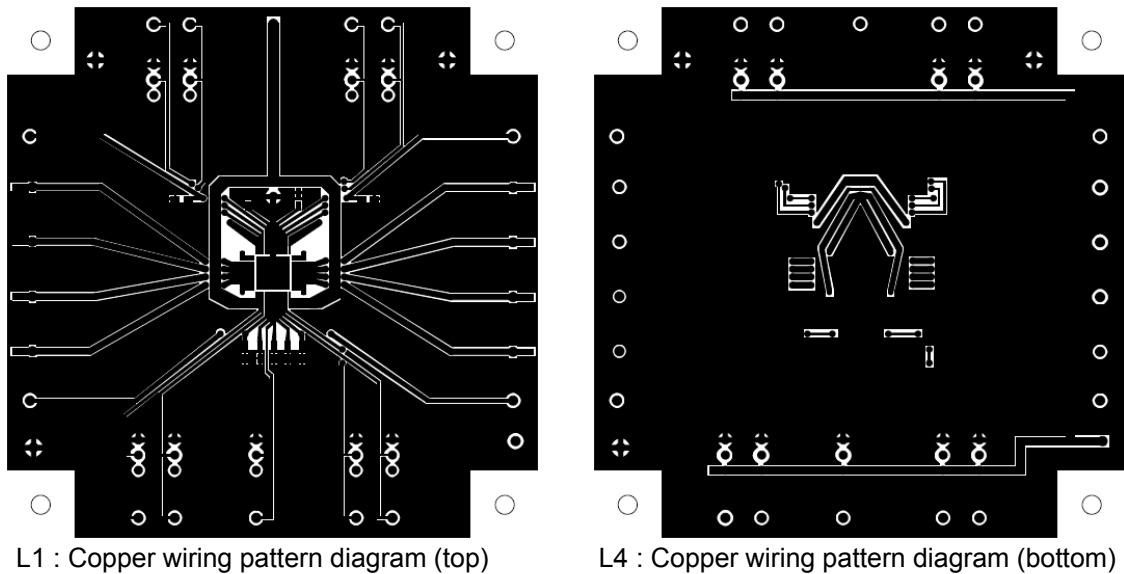


Figure 35. Pattern Diagram of Top and Bottom Layer

Recommendation

The thermal data provided is for the thermal test condition where 90% or more of the exposed die pad is soldered.

It is recommended to derate critical rating parameters for a safe design. Electrical parameters that are recommended to be derated are operating voltage, operating current, junction temperature, and device power dissipation. The recommended derating for a safe design is as shown below:

- Maximum 80% or less for operating voltage

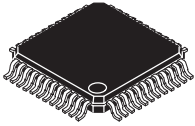
- Maximum 80% or less for operating current
- Maximum 80% or less for junction temperature

Check solder joints and verify reliability of solder joints for critical areas such as exposed die pad, power pins and grounds.

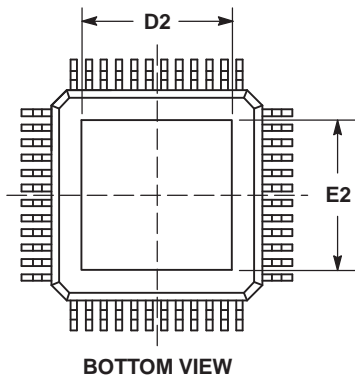
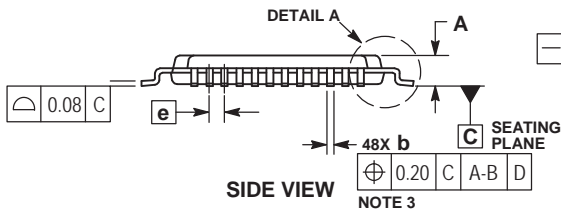
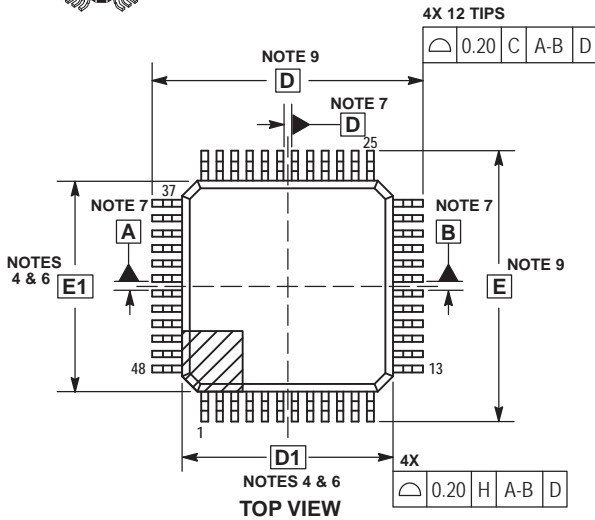
Any void or deterioration, if observed, in solder joint of these critical areas parts, may cause deterioration in thermal conduction and that may lead to thermal destruction of the device.

LV8714TA

PACKAGE DIMENSIONS



TQFP48 EP 7x7, 0.5P
CASE 932F
ISSUE C

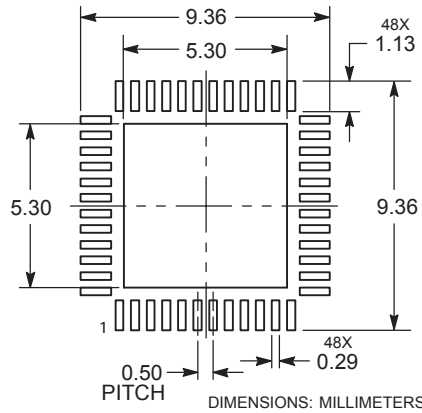


NOTES:

1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL BE 0.08 MAX. AT MMC. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD IS 0.07.
4. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. DIMENSIONS D1 AND E1 ARE MAXIMUM PLASTIC BODY SIZE INCLUDING MOLD MISMATCH.
5. THE TOP PACKAGE BODY SIZE MAY BE SMALLER THAN THE BOTTOM PACKAGE SIZE BY AS MUCH AS 0.15.
6. DATUMS A-B AND D ARE DETERMINED AT DATUM PLANE H.
7. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.
8. DIMENSIONS D AND E TO BE DETERMINED AT DATUM PLANE C.

DIM	MILLIMETERS	
	MIN	MAX
A	0.95	1.25
A1	0.05	0.15
A2	0.90	1.20
b	0.17	0.27
D	9.00 BSC	
D1	7.00 BSC	
D2	4.90	5.10
E	9.00 BSC	
E1	7.00 BSC	
E2	4.90	5.10
e	0.50 BSC	
L	0.45	0.75
L2	0.25 BSC	
M	0°	7°

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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